



N-Channel 100-V (D-S) 175 °C MOSFET

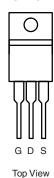
PRODUCT SUMMARY			
V _{(BR)DSS} (V)	$r_{DS(on)}(\Omega)$	I _D (A)	
100	0.030 at V _{GS} = 10 V	40	
	0.034 at V _{GS} = 6 V	37.5	

FEATURES

- TrenchFET® Power MOSFET
- 175 °C Junction Temperature

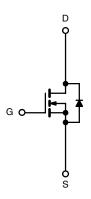


TO-220AB



Ordering Information: SUP40N10-30

SUP40N10-30-E3 (Lead (Pb)-free)



N-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS	$T_C = 25 ^{\circ}C$, unless ot	nerwise noted		
Parameter		Symbol	Limit	Unit
Drain-Source Voltage		V _{DS}	100	V
Gate-Source Voltage		V _{GS}	± 20	
Continuous Drain Current (T _{.I} = 175 °C)	T _C = 25 °C	I-	40	
Continuous Diam Current (1) = 175 C)	T _C = 125 °C	I _D	23	
Pulsed Drain Current		I _{DM}	75	_ A
Avalanche Current		I _{AS}	35	
Single Pulse Avalanche Energy ^a	L = 0.1 mH	= 0.1 mH E _{AS} 61		mJ
Maximum Power Dissipation ^a	T _C = 25 °C	В	107 ^b	14/
	T _A = 25 °C ^c	$ P_D$ $-$	3.75	W
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 175	°C

THERMAL RESISTANCE RATINGS					
Parameter		Symbol	Limit	Unit	
Junction-to-Ambient	PCB Mount ^c	- R _{thJA}	40	°C/W	
dunction to Ambient	Free Air		62.5		
Junction-to-Case (Drain)		R _{thJC}	1.4		

Notes:

- a. Duty cycle \leq 1 %.
- b. See SOA curve for voltage derating.
- c. When Mounted on 1" square PCB (FR-4 material).
- * Pb containing terminations are not RoHS compliant, exemptions may apply.

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SPECIFICATIONS $T_J = 25$		otherwise noted				
Parameter	Symbol	Test Conditions	Min	Тур	Max	Unit
Static				_		
Drain-Source Breakdown Voltage	V _{(BR)DSS}	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$	100			V
Gate Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	2		4	
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			± 100	nA
Zero Gate Voltage Drain Current		$V_{DS} = 80 \text{ V}, V_{GS} = 0 \text{ V}$			1	μΑ
	I _{DSS}	V_{DS} = 80 V, V_{GS} = 0 V, T_{J} = 125 °C			50	
		$V_{DS} = 80 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 175 ^{\circ}\text{C}$			250	
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 5 \text{ V}, V_{GS} = 10 \text{ V}$	75			Α
Drain-Source On-State Resistance ^a		V _{GS} = 10 V, I _D = 15 A		0.024	0.030	
	r	V _{GS} = 6 V, I _D = 10 A		0.026	0.034	Ω
	r _{DS(on)}	V _{GS} = 10 V, I _D = 15 A, T _J = 125 °C			0.054	
		V _{GS} = 10 V, I _D = 15 A, T _J = 175 °C			0.067	
Forward Transconductance ^a	9 _{fs}	V _{DS} = 15 V, I _D = 15 A	10			S
Dynamic ^b	!			*	!	
Input Capacitance	C _{iss}			2400		pF
Output Capacitance	C _{oss}	V _{GS} = 0 V, V _{DS} = 25 V, f = 1 MHz		270		
Reverse Transfer Capacitance	C _{rss}			90		
Total Gate Charge ^c	Qg			35	60	nC
Gate-Source Charge ^c	Q_{gs}	$V_{DS} = 50 \text{ V}, V_{GS} = 10 \text{ V}, I_{D} = 40 \text{ A}$		11		
Gate-Drain Charge ^c	Q _{gd}			9		
Gate Resistance	R _g			1.7		Ω
Turn-On Delay Time ^c	t _{d(on)}			11	20	ns .
Rise Time ^c	t _r	$V_{DD} = 50 \text{ V}, R_{L} = 1.25 \Omega$		12	20	
Turn-Off Delay Time ^c	t _{d(off)}	$I_D \cong 40 \text{ A}, V_{GEN} = 10 \text{ V}, R_G = 2.5 \Omega$		30	45	
Fall Time ^c	t _f			12	20	
Source-Drain Diode Ratings and Cha	aracteristics	(T _C = 25 °C) ^b				
Continuous Current	Is				40	
Pulsed Current	I _{SM}				75	Α
Forward Voltage ^a	V _{SD}	I _F = 30 A, V _{GS} = 0 V		1.0	1.5	V
Reverse Recovery Time	t _{rr}	1 2 30		60	100	ns
Peak Reverse Recovery Current	I _{RM(REC)}	I _F = 30 A, di/dt = 100 A/μs		5	8	A
Reverse Recovery Charge	Q _{rr}	F 22.3 20.21 121.4 Mg		0.15	0.4	μC

Notes:

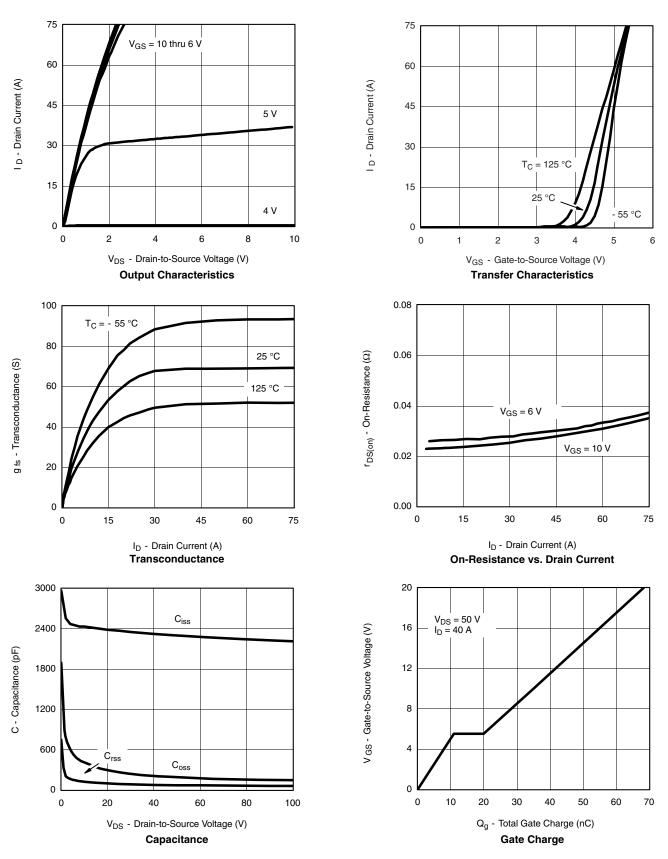
- a. Pulse test; pulse width $\leq 300~\mu s,$ duty cycle $\leq 2~\%.$
- b. Guaranteed by design, not subject to production testing.
- c. Independent of operating temperature.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.





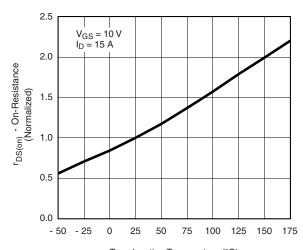
TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



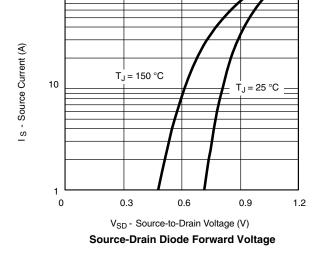
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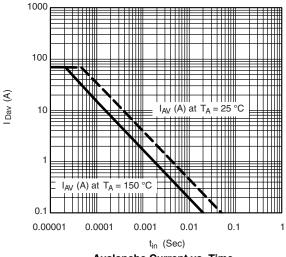
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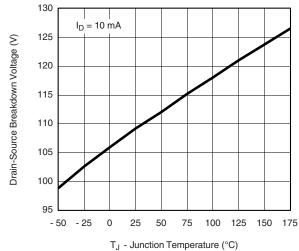
T_J - Junction Temperature (°C) On-Resistance vs. Junction Temperature



100



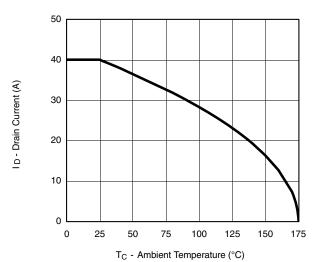
Avalanche Current vs. Time



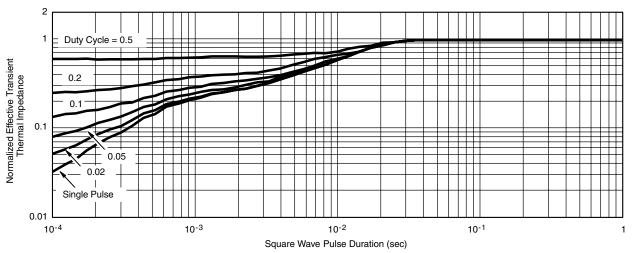
Drain-Source Breakdown Voltage vs. Junction Temperature



THERMAL RATINGS



Maximum Avalanche and Drain Current vs. Case Temperature



Normalized Thermal Transient Impedance, Junction-to-Case

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